# International TOR Rectifier

## REPETITIVE AVALANCHE AND dv/dt RATED HEXFET®TRANSISTORS SURFACE MOUNT (LCC-18)

## JANTX2N6790U REF:MIL-PRF-19500/555 200V, N-CHANNEL

## **Product Summary**

Part Number	Bvdss	RDS(on)	ΙD	
IRFE220	100V	0.80Ω	2.8A	

The leadless chip carrier (LCC) package represents the logical next step in the continual evolution of surface mount technology. Desinged to be a close replacement for the TO-39 package, the LCC will give designers the extra flexibility they need to increase circuit board density. International Rectifier has engineered the LCC package to meet the specific needs of the power market by increasing the size of the bottom source pad, thereby enhancing the thermal and electrical performance. The lid of the package is grounded to the source to reduce RF interference.



### Features:

- Surface Mount
- Small Footprint
- Alternative to TO-39 Package
- Hermetically Sealed
- Dynamic dv/dt Rating
- Avalanche Energy Rating
- Simple Drive Requirements
- Light Weight

## **Absolute Maximum Ratings**

	Parameter		Units
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	2.8	
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	1.8	Α
IDM Pulsed Drain Current ①		11	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	14	W
	Linear Derating Factor	0.11	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	0.242	mJ
IAR Avalanche Current ①		2.2	Α
EAR Repetitive Avalanche Energy ①		1.4	mJ
dv/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns
TJ	Operating Junction	-55 to 150	
TSTG Storage Temperature Range			°c
	Pckg. Mounting Surface Temp.	300 (for 5s)	
	Weight	0.42(typical)	g

For footnotes refer to the last page

## Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	200	_		V	VGS = 0V, ID = 1.0mA
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	_	0.25	_	V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA
RDS(on)	Static Drain-to-Source On-State	_	_	0.80		V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.8A@
, ,	Resistance	_	_	0.85	Ω	$V_{GS} = 10V, I_{D} = 2.8A$
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA
9fs	Forward Transconductance	1.5	_	_	S	V <sub>DS</sub> > 15V, I <sub>DS</sub> = 1.8A④
IDSS	Zero Gate Voltage Drain Current	_	_	25		V <sub>DS</sub> = 160V, V <sub>GS</sub> = 0V
		_	_	250	μΑ	V <sub>DS</sub> = 160V
						$V_{GS} = 0V$ , $T_{J} = 125$ °C
IGSS	Gate-to-Source Leakage Forward	_	_	100	nA	VGS = 20V
IGSS	Gate-to-Source Leakage Reverse	_	_	-100	ПА	VGS = -20V
Qg	Total Gate Charge	_	_	14.3		VGS = 10V, ID = 2.8A
Qgs	Gate-to-Source Charge	_	_	3.0	nC	$V_{DS} = 100V$
Q <sub>gd</sub>	Gate-to-Drain ('Miller') Charge	_	_	9.0		
<sup>t</sup> d(on)	Turn-On Delay Time	_	_	40		$V_{DD} = 74V, I_{D} = 2.8A$
tr	Rise Time	_	_	50	ns	$V_{GS} = 10V$ , $R_{G} = 7.5\Omega$
<sup>t</sup> d(off)	Turn-Off Delay Time	_	_	50	115	
tf	Fall Time	_	_	50		
L <sub>S+</sub> L <sub>D</sub>	Total Inductance	_	6.1	_	nΗ	Measured from the center of drain pad to center of source pad
C <sub>iss</sub>	Input Capacitance		260			VGS = 0V, VDS = 25V
Coss	Output Capacitance	_	100	_	pF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance	_	30	_		

## **Source-Drain Diode Ratings and Characteristics**

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)		_	_	2.8	Α	
Ism	Pulse Source Current (Body Diode) ①		_	_	11	^	
VSD	Diode Forward Voltage		_	_	1.5	V	$T_j = 25^{\circ}C$ , $I_S = 2.8A$ , $V_{GS} = 0V$ @
t <sub>rr</sub>	Reverse Recovery Time		_	_	400	ns	$T_j = 25^{\circ}C$ , $I_F = 2.8A$ , $di/dt \le 100A/\mu s$
QRR	Reverse Recovery Charge		_	_	4.3	μC	V <sub>DD</sub> ≤ 50V ④
ton	Forward Turn-On Time	ime Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

## **Thermal Resistance**

	Parameter	Min	Тур	Max	Units	Test Conditions
R <sub>th</sub> JC	Junction to Case	_	_	8.93	°C/W	
RthJ-PCB	Junction to PC Board	_	_	26	C/VV	Soldered to a copper clad PC board

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

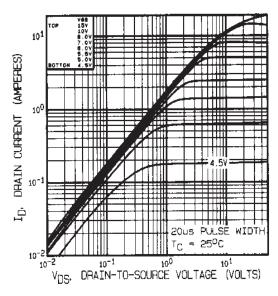


Fig 1. Typical Output Characteristics

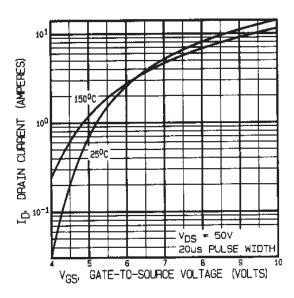


Fig 3. Typical Transfer Characteristics

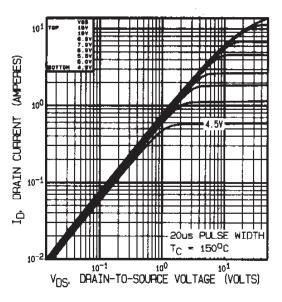
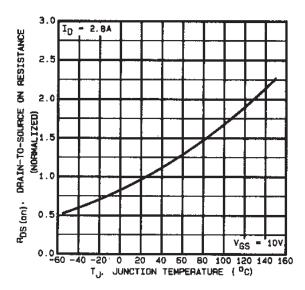
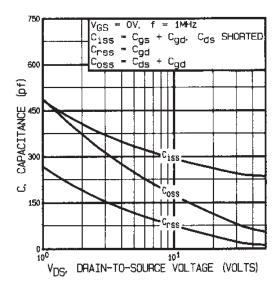


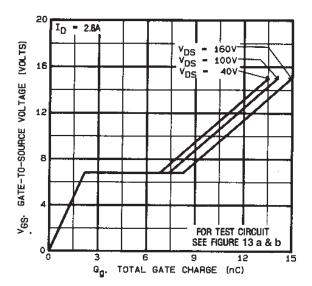
Fig 2. Typical Output Characteristics



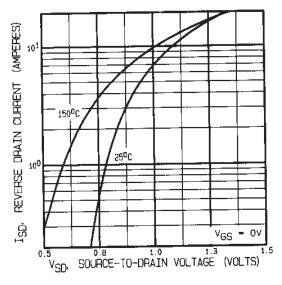
**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

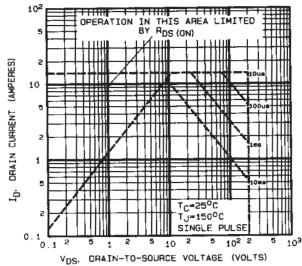


Fig 8. Maximum Safe Operating Area

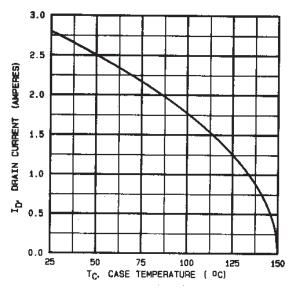


Fig 9. Maximum Drain Current Vs. Case Temperature

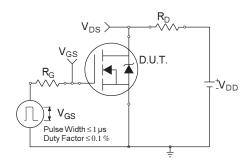


Fig 10a. Switching Time Test Circuit

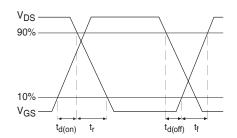


Fig 10b. Switching Time Waveforms

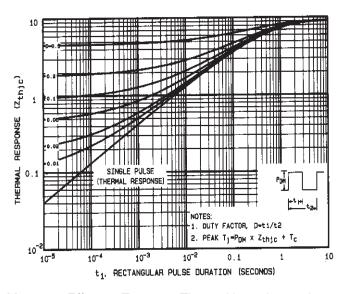


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

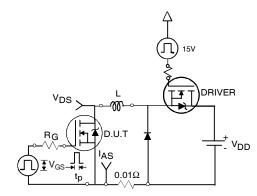


Fig 12a. Unclamped Inductive Test Circuit

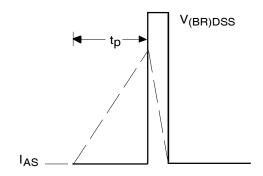


Fig 12b. Unclamped Inductive Waveforms

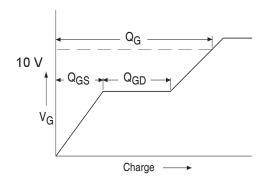


Fig 13a. Basic Gate Charge Waveform

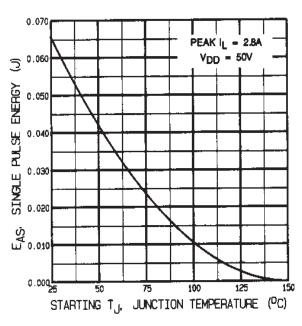


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

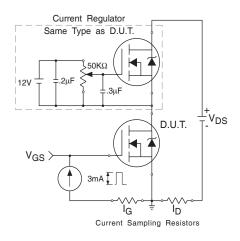


Fig 13b. Gate Charge Test Circuit

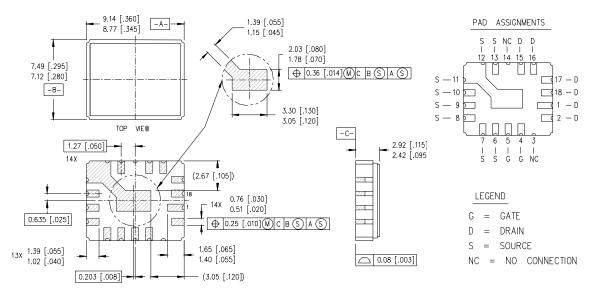
## IRFE220, JANTX2N6790U

### **Foot Notes:**

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ②  $V_{DD}$  = 50V, starting  $T_J$  = 25°C, Peak  $I_L$  = 2.2A, L = 100 $\mu$ H

- ③ IsD  $\leq$  2.8A, di/dt  $\leq$  94A/ $\mu$ s, VDD $\leq$  200V, TJ  $\leq$  150°C Suggested RG = 7.5  $\Omega$
- 4 Pulse width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2%

## Case Outline and Dimensions — LCC-18



#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
- 2, CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

# International TOR Rectifier

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